

Features

- Low Profile Package for Surface Mounting(Flat Handling Surface for Accurate Placement)
- Zener Voltage 5.1V to 200V
- Available on Tape and Reel
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant

Mechanical Data

Case : Molded plastic body

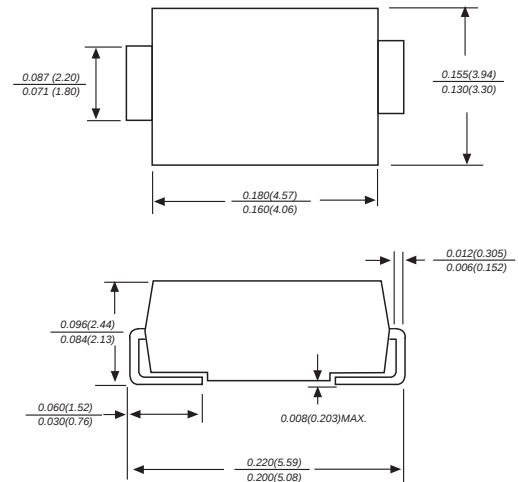
Terminals : Solder plated, solderable per MIL-STD-750,Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any

Weight : 0.0035 ounce, 0.098 grams

DO-214AA/SMB



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbols	Value	Unit
DC Power dissipation at $T_L = 75^\circ\text{C}^{(1)}$	P_D	5.0	W
Maximum forward voltage at $I_F=1\text{A}$	V_F	1.2	V
Junction temperature range	T_J, T_{STG}	-55 to +150	°C
Storage temperature range	T_J, T_{STG}	-55 to +150	°C

Note :

(1) T_L =Lead temperature at 3/8" (9.5mm)from body

Part Number	Regulator Voltage	Test Current	Maximum Dynamic Impedance	Maximum Reverse Current	Test Voltage	Maximum Regulator Current	Maximum Dynamic Knee Impedance	Maximum Surge Current	Maximum Voltage Regulation
	V_Z V	I_Z mA	Z_{ZT} Ω	I_R μA	V_R V	I_{ZM} mA	$Z_{ZK} @ 1.0mA$ Ω	I_{ZSM} A	V
SMBJ5338B	5.1	240	1.5	1	1	930	400	14.4	0.39
SMBJ5339B	5.6	220	1	1	2	865	400	13.4	0.25
SMBJ5340B	6	200	1	1	3	790	300	12.7	0.19
SMBJ5341B	6.2	200	1	1	3	765	200	12.4	0.1
SMBJ5342B	6.8	175	1	10	5.2	700	200	11.5	0.15
SMBJ5343B	7.5	175	1.5	10	5.7	630	200	10.7	0.15
SMBJ5344B	8.2	150	1.5	10	6.2	580	200	10	0.2
SMBJ5345B	8.7	150	2	10	6.6	545	200	9.5	0.2
SMBJ5346B	9.1	150	2	7.5	6.9	520	150	9.2	0.22
SMBJ5347B	10	125	2	5	7.6	475	125	8.6	0.22
SMBJ5348B	11	125	2.5	5	8.4	430	125	8	0.25
SMBJ5349B	12	100	2.5	2	9.1	395	125	7.5	0.25
SMBJ5350B	13	100	2.5	1	9.9	365	100	7	0.25
SMBJ5351B	14	100	2.5	1	10.6	340	75	6.7	0.25
SMBJ5352B	15	75	2.5	1	11.5	315	75	6.3	0.25
SMBJ5353B	16	75	2.5	1	12.2	295	75	6	0.3
SMBJ5354B	17	70	2.5	0.5	12.9	280	75	5.8	0.35
SMBJ5355B	18	65	2.5	0.5	13.7	264	75	5.5	0.4
SMBJ5356B	19	65	3	0.5	14.4	250	75	5.3	0.4
SMBJ5357B	20	65	3	0.5	15.2	237	75	5.1	0.4
SMBJ5358B	22	50	3.5	0.5	16.7	216	75	4.7	0.45
SMBJ5359B	24	50	3.5	0.5	18.2	198	100	4.4	0.55
SMBJ5360B	25	50	4	0.5	19	190	110	4.3	0.55
SMBJ5361B	27	50	5	0.5	20.6	176	120	4.1	0.6
SMBJ5362B	28	50	6	0.5	21.2	170	130	3.9	0.6
SMBJ5363B	30	40	8	0.5	22.8	158	140	3.7	0.6
SMBJ5364B	33	40	10	0.5	25.1	144	150	3.5	0.6
SMBJ5365B	36	30	11	0.5	27.4	132	160	3.3	0.65
SMBJ5366B	39	30	14	0.5	29.7	122	170	3.1	0.65
SMBJ5367B	43	30	20	0.5	32.7	110	190	2.8	0.7
SMBJ5368B	47	25	25	0.5	35.8	100	210	2.7	0.8
SMBJ5369B	51	25	27	0.5	38.8	93	230	2.5	0.9
SMBJ5370B	56	20	35	0.5	42.6	86	280	2.3	1
SMBJ5371B	60	20	40	0.5	45.5	79	350	2.2	1.2
SMBJ5372B	62	20	42	0.5	47.1	76	400	2.1	1.35
SMBJ5373B	68	20	44	0.5	51.7	70	500	2	1.5
SMBJ5374B	75	20	45	0.5	56	63	620	1.9	1.6
SMBJ5375B	82	15	65	0.5	62.2	58	720	1.8	1.8
SMBJ5376B	87	15	75	0.5	66	54.5	760	1.7	2
SMBJ5377B	91	15	75	0.5	69.2	52.5	760	1.6	2.2
SMBJ5378B	100	12	90	0.5	76	47.5	800	1.5	2.3
SMBJ5379B	110	12	125	0.5	83.6	43	1000	1.4	2.5
SMBJ5380B	120	10	170	0.5	91.2	39.5	1150	1.3	2.5
SMBJ5381B	130	10	190	0.5	98.8	36.6	1250	1.2	2.5
SMBJ5382B	140	8.0	230	0.5	106	34	1500	1.2	2.5
SMBJ5383B	150	8.0	330	0.5	114	31.6	1500	1.1	3
SMBJ5384B	160	8.0	350	0.5	122	29.4	1650	1.1	3
SMBJ5385B	170	8.0	380	0.5	129	28	1750	1.0	3
SMBJ5386B	180	5.0	430	0.5	137	26.4	1750	1.0	4
SMBJ5387B	190	5.0	450	0.5	144	25	1850	0.9	5
SMBJ5388B	200	5.0	480	0.5	152	23.6	1850	0.9	5

Remarks:

1. Devices Listed Have a $\pm 5\%$ Tolerance on Nominal V_Z . Suffix C Denotes a $+2\%$

Ratings And Characteristic Curves

Fig. 1 - Power Derating Curve

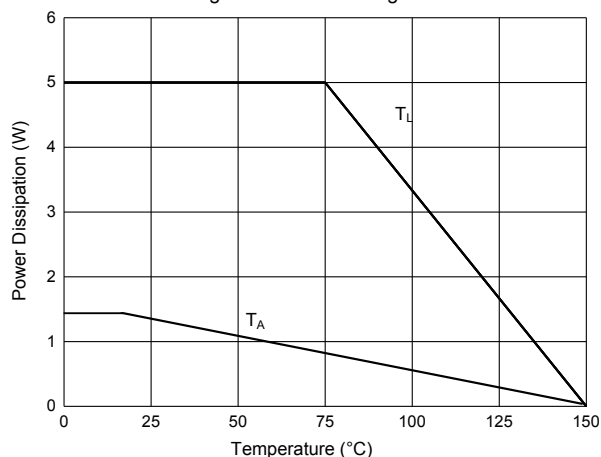


Fig. 2 - Typical Zener Breakdown Characteristics

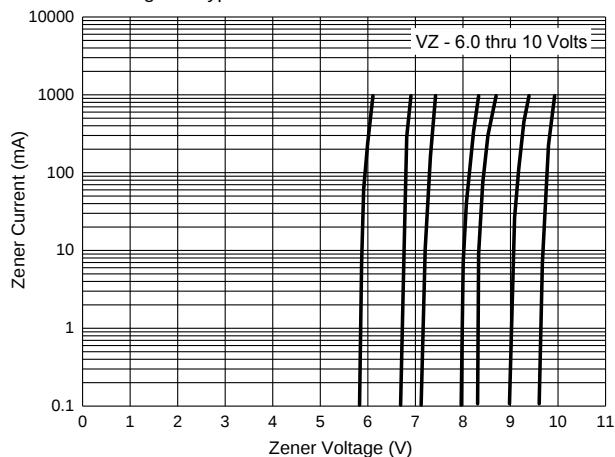


Fig. 3 - Typical Zener Breakdown Characteristics

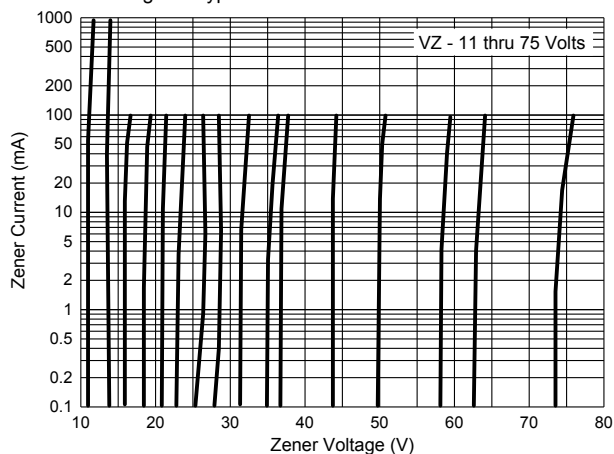
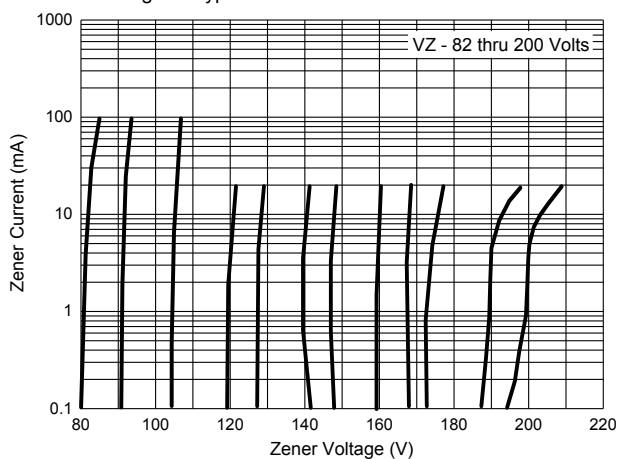
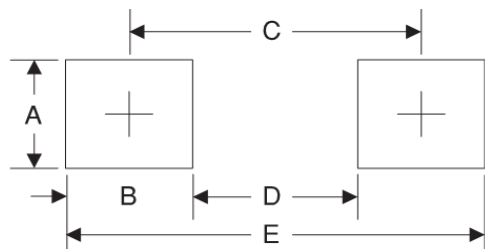


Fig. 4 - Typical Zener Breakdown Characteristics

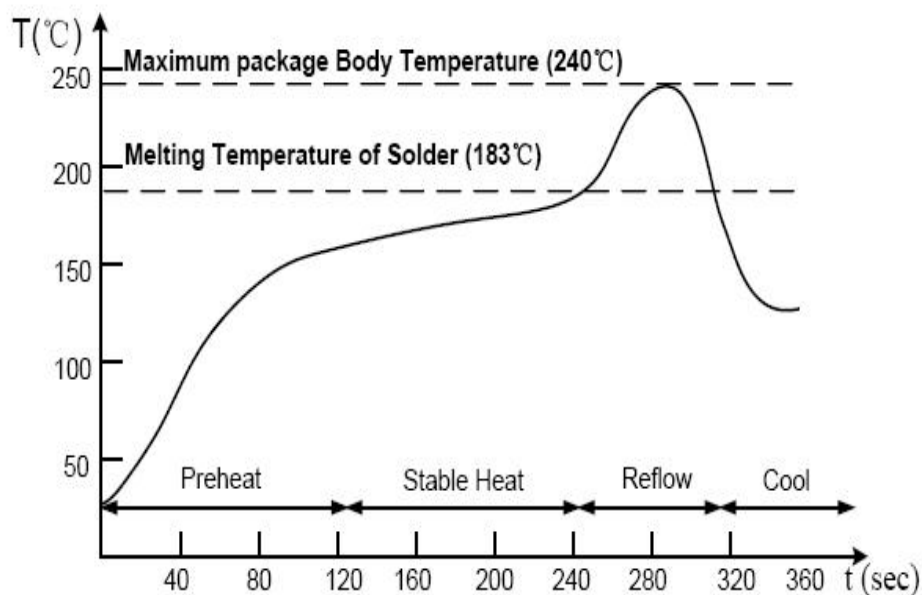


Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	2.30	0.091
B	2.00	0.078
C	4.10	0.161
D	2.10	0.083
E	6.10	0.240

Suggested Soldering Temperature Profile

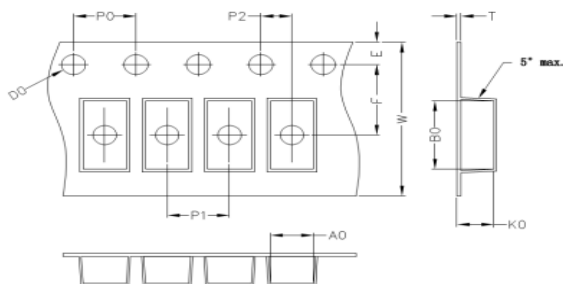


Note

- Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- The device can be exposed to a maximum temperature of 265°C for 10 seconds.
- Devices can be cleaned using standard industry methods and solvents.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Package Information

Carrier Dimension(mm)



A0	B0	K0	D0	E	F
3.80	5.40	2.45	1.55	1.75	5.50
P0	P1	P2	T	W	Tolerance
4.0	8.0	2.0	0.25	12	0.1

Package Specifications

Package	Reel Size	Reel DIA. (mm)	Q'TY/Reel (Kpcs)	Box Size (mm)	QTY/Box (Kpcs)	Carton Size (mm)	Q'TY/Carton (Kpcs)
SMB	13'	330	3.0	340	6.0	360*360*360	48

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